

Low Power, High Performance Operational Amplifier

March 1993

Features

- High Slew Rate 20V/ μ s
- Low Power Dissipation 2.25mW at $\pm 15.0V$
- High Open Loop Gain 300kV/V ($R_L = 2k\Omega$)
- Low Input Bias Current5nA
- Low Offset Voltage 1mV
- High CMRR 106dB
- Wide Power Supply Range $\pm 5.5V$ to $\pm 20.0V$
- Fully Internally Compensated
- Output Short Circuit Protected
- Offset Null Capability

Applications

- Instrumentation
- Battery Powered Circuits
- Portable Instruments
- Remote Data Logging

Description

The HA-2705 is a general purpose amplifier which operates at very low power levels without compromising large signal response characteristics or output drive capability. Advanced circuit design techniques and the use of vertical NPN and PNP transistors make possible the attainment of very high gain with a single stage of voltage amplification. This ensures closed loop stability even in the critical unity gain follower mode, without the use of external compensation components.

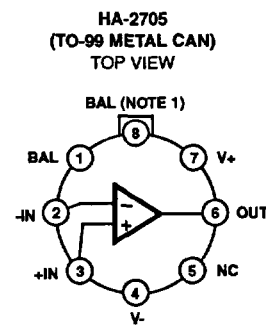
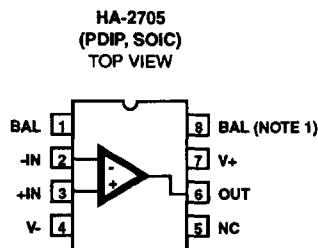
The circuit is intended for use in applications that require fast large signal response with low power dissipation and for instrumentation applications in which low offset voltage, low bias current drift, large voltage gain and high common mode rejection are necessary. Full output short circuit protection and the large differential input breakdown enable the device to withstand a variety of fault conditions.

For military grade product, please refer to the HA-2700/883 datasheet.

Ordering Information

PART NUMBER	TEMPERATURE RANGE	PRODUCT DESCRIPTION
HA3-2705-5	0°C to +70°C	8 Lead Plastic DIP
HA9P2705-5	0°C to +70°C	8 Lead SOIC
HA2-2705-5	0°C to +70°C	8 Pin TO-99 Metal Can

Pinouts



CAUTION: These devices are sensitive to electrostatic discharge. Users should follow proper I.C. Handling Procedures.
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File Number **3391**

Specifications HA-2705

Absolute Maximum Ratings

Voltage Between V+ and V- Terminals	44.0V
Differential Input Voltage	18V
Input Voltage	V+ to V-
Junction Temperature (Hermetic)	+175°C
Junction Temperature (Plastic Package)	+150°C
Lead Temperature (Soldering 10s)	+300°C

Operating Conditions

HA-2705-5	0°C ≤ T _A ≤ +75°C	
Storage Temperature Range	-65°C ≤ T _A ≤ +150°C	
Thermal Resistance (°C/W)	θ _{JA}	θ _{JC}
Plastic DIP Package	94	32
SOIC Package	157	43
TO-99 Metal Can	114	35

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

Electrical Specifications V+ = +15V, V- = -15V, R_L = 5kΩ Unless Otherwise Specified.

PARAMETER	TEMP	HA-2705-5			UNITS
		MIN	TYP	MAX	
INPUT CHARACTERISTICS					
Offset Voltage (Note 1)	+25°C	-	1.0	5.0	mV
	Full	-	-	7.0	mV
Bias Current	+25°C	-	5.0	40.0	nA
	Full	-	-	70.0	nA
Offset Current	+25°C	-	2.5	15.0	nA
	Full	-	-	40.0	nA
Common Mode Range	Full	±11.0	-	-	V
TRANSFER CHARACTERISTICS					
Large Signal Voltage Gain (Notes 2 and 3)	+25°C	200	300	-	kV/V
	Full	100	-	-	kV/V
Common Mode Rejection Ratio (Note 4)	Full	80	106	-	dB
Gain Bandwidth Product (Note 2)	+25°C	-	1.0	-	MHz
Minimum Stable Gain	Full	1	-	-	V/V
OUTPUT CHARACTERISTICS					
Output Voltage Swing (Note 2)	+25°C	±12.0	±13.0	-	V
	Full	±11.0	-	-	V
Output Current (Note 3)	+25°C	-	10	-	mA
TRANSIENT RESPONSE CHARACTERISTICS					
Slew Rate (Notes 2 and 6)	+25°C	10	20	-	V/μs
POWER SUPPLY CHARACTERISTICS					
Supply Current	+25°C	-	75	150	μA
	Full	-	-	200	μA
Power Supply Rejection Ratio (Note 5)	Full	80	100	-	dB

NOTES:

1. Can be adjusted to zero with 1MΩ potentiometer between Pins 1 and 8 with the wiper to V+.
2. R_L = 2kΩ, C_L = 100pf
3. V_O = ±10.0V
4. V_{CM} = ±5.0V
5. V_S = ±10.0V to ±20.0V
6. A_V = 5

Die Characteristics

DIE DIMENSIONS:

70 x 60 x 19 ± 1mils

METALLIZATION:

Type: Al, 1% Cu

Thickness: 16kÅ ± 2kÅ

GLASSIVATION:

Type: Nitride (Si₃N₄) over Silox (SiO₂, 5% Phos)

Silox Thickness: 12kÅ ± 2kÅ

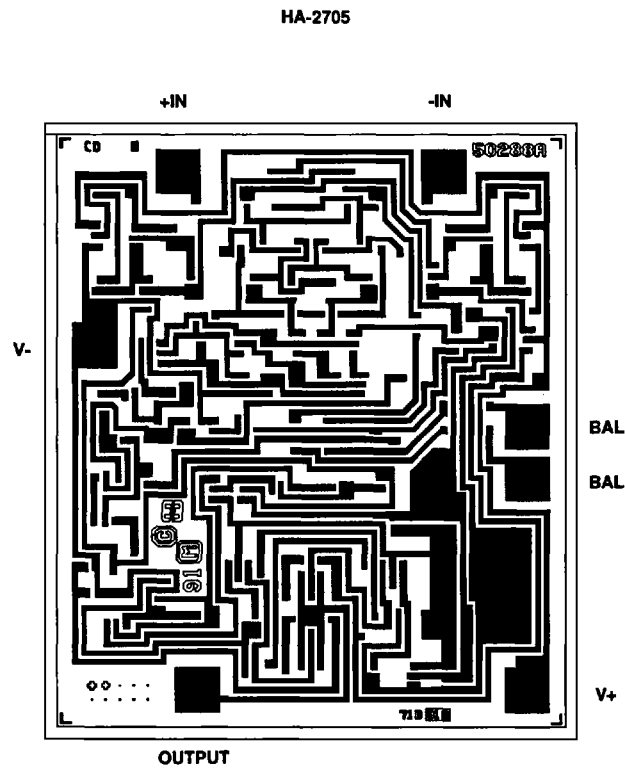
Nitride Thickness: 3.5kÅ ± 2kÅ

DIE ATTACH:

Material: Silver Epoxy - Plastic DIP and SOIC

Silver Epoxy - TO-99 Metal Can

Metallization Mask Layout



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OPERATIONAL
AMPLIFIERS